						March 199
	юолочетс 6324L	JH ™				
-	grated Load	I Switch				
Senera	I Description			Features		
airchild echnold special rovide re part witch a	ntegrated Load S d's proprietary, ogy. This very lly tailored to mini superior switching ticularly suited fo upplication where I g are needed.	high cell de high densit imize on-state g performance. r low voltage	ensity, DMOS y process is resistance and . These devices high side load	V _{DROP} =0.3V ■ High density ■ V _{ON/OFF} Zene >6KV Huma ■ SuperSOT [™]	ⓐ V_{IN} =12V, I_L =1A, V_{ON} ⓐ V_{IN} =5V, I_L =1A, V_{ONO} cell design for extrem r protection for ESD ru n Body Model. -6 package design usi mal and electrical cap	FFF=1.5 to 8V. ely low on-resistance. Iggedness. ng copper lead frame
SOT-	23 Sur	perSOT [™] -6	SuperSOT [™] -8	SO-8	SOT-223	SOIC-16
			Vin,R1 4		Vout,C1 EQUI Vout,C1 IN 0	
-	pin 1 erSOT [™] -6	Range T	ON/OFF 5 R1,C1 6 See	Application Circuit	Vout,C1	
bsolu	erSOT [™] -6	Range T,	0N/0FF 5 R1,C1 6	Application Circuit	Vout,C1	y vorter of our
bsolu mbol	erSOT [™] -6 ute Operating		ON/OFF 5 R1,C1 6 See	Application Circuit	Vout,C1 IN 0	V _{DROP} O OUT
bsolu mbol	erSOT [™] -6 ute Operating Parameter	nge	ON/OFF 5 R1,C1 6 See	Application Circuit	Vout,C1 IN 0	v v o o o u 1 → F o Units
bsolu mbol	erSOT [™] -6 ute Operating Parameter Input Voltage Rar	nge Range / _{_{DROP}=0.5V - Cor}	ON/OFF 5 R1,C1 6 See $A = 25^{\circ}C$ unless otherwise ntinuous (Note 1)	Application Circuit	Vout,C1 Vout,C1 IN O ON/OF R2 FDC6324L 3 - 20 1.5 - 8 1.5	F O Units
bsolu mbol	erSOT [™] -6 ute Operating Parameter Input Voltage Ran ON/OFF Voltage Load Current @ V	nge Range / _{DROP} =0.5V - Cor -	N/OFF 5 R1,C1 6 See A = 25°C unless otherwise ntinuous (Note 1) Pulsed (Note 1 & 3)	Application Circuit	Vout,C1 IN O Vout,C1 IN O R2 ON/OF FDC6324L 3 - 20 1.5 - 8 1.5 2.5	о олл о олл о олл о олл о олл о олл о о о о о
bsolu mbol	erSOT TM -6	nge Range / _{DROP} =0.5V - Cor - Dissipation	0 N/0 FF 5 R1,C1 6 See A = 25°C unless otherwise ntinuous (Note 1) PulSed (Note 1 & 3) (Note 2a)	Application Circuit	Vout,C1 IN 0 Vout,C1 IN 0 R2 FDC6324L 3 - 20 1.5 - 8 1.5 2.5 0.7	vonor vo
mbol worf T _{STG}	erSOT [™] -6 Ute Operating Parameter Input Voltage Rar ON/OFF Voltage Load Current @ \ Maximum Power Operating and Sto	nge Range / _{DROP} =0.5V - Cor Dissipation Drage Temperati harge Rating MII	0 N/0 FF 5 R1,C1 6 See A = 25°C unless otherwise ntinuous (Note 1) PulSed (Note 1 & 3) (Note 2a)	Application Circuit	Vout,C1 IN O Vout,C1 IN O R2 ON/OF FDC6324L 3 - 20 1.5 - 8 1.5 2.5	vorop vo
	erSOT [™] -6 Ute Operating Parameter Input Voltage Rar ON/OFF Voltage Load Current @ V Maximum Power Operating and Sto Electrostatic Disch	nge Range / _{DROP} =0.5V - Cor Dissipation Drage Temperatu harge Rating MII 00hm)	0 N/0 FF 5 R1,C1 6 See A = 25°C unless otherwise ntinuous (Note 1) Pulsed (Note 1 & 3) (Note 2a) ure Range	Application Circuit	Vout,C1 IN ○ Vout,C1 IN ○ R2 ON/OF FDC6324L ON/OF 3 - 20 1.5 - 8 1.5 - 8 1.5 2.5 0.7 -555 to 150 150	v o out
MOFF T _{STG}	erSOT [™] -6 ute Operating Parameter Input Voltage Ran ON/OFF Voltage Load Current @ V Maximum Power Operating and Sto Electrostatic Disch Model (100pf/150	nge Range / _{DROP} =0.5V - Cor - Dissipation orage Temperati harge Rating MII 0Ohm) CS	N/OFF 5 R1,C1 6 R1,C1 6 See A = 25°C unless otherwise ntinuous (Note 1) Pulsed (Note 1 & 3) (Note 2a) ure Range L-STD-883D Human Boo	Application Circuit	Vout,C1 IN ○ Vout,C1 IN ○ R2 ON/OF FDC6324L ON/OF 3 - 20 1.5 - 8 1.5 - 8 1.5 2.5 0.7 -555 to 150 150	v o out

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FDC6324L Rev. D

Electrical Characteristics (T _A = 25°C unless otherwise noted)								
Symbol	Parameter	Conditions	Min	Тур	Max	Units		
OFF CHA	RACTERISTICS							
I _{FL}	Forward Leakage Current	$V_{IN} = 20 \text{ V}, V_{ONOFF} = 0 \text{ V}$			1	μA		
I _{rl}	Reverse Leakage Current	$V_{IN} = -20 \text{ V}, V_{ONOFF} = 0 \text{ V}$			-1	μA		
ON CHAR	ACTERISTICS (Note 3)							
V _{IN}	Input Voltage		3		20	V		
VONVOFF	On/Off Voltage		1.5		8	V		
V _{DROP}	Conduction Voltage Drop @ 1A	$V_{IN} = 10 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$		0.135	0.2	V		
		$V_{IN} = 5 V, V_{ONOFF} = 3.3 V$		0.215	0.3			
I _L	Load Current	$V_{DROP} = 0.2 \text{ V}, V_{IN} = 10 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$	1			А		
		$V_{\text{DROP}} = 0.3 \text{ V}, V_{\text{IN}} = 5 \text{ V}, V_{\text{ON/OFF}} = 3.3 \text{ V}$	1					

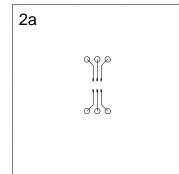
Notes:

1. V_{IN} =20V, V_{ONOFF} =8V, V_{DROP} =0.5V, T_A =25°C

2. R_{BM} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{BC} is guaranteed by design while $\mathsf{R}_{_{\theta CA}}$ is determined by the user's board design.

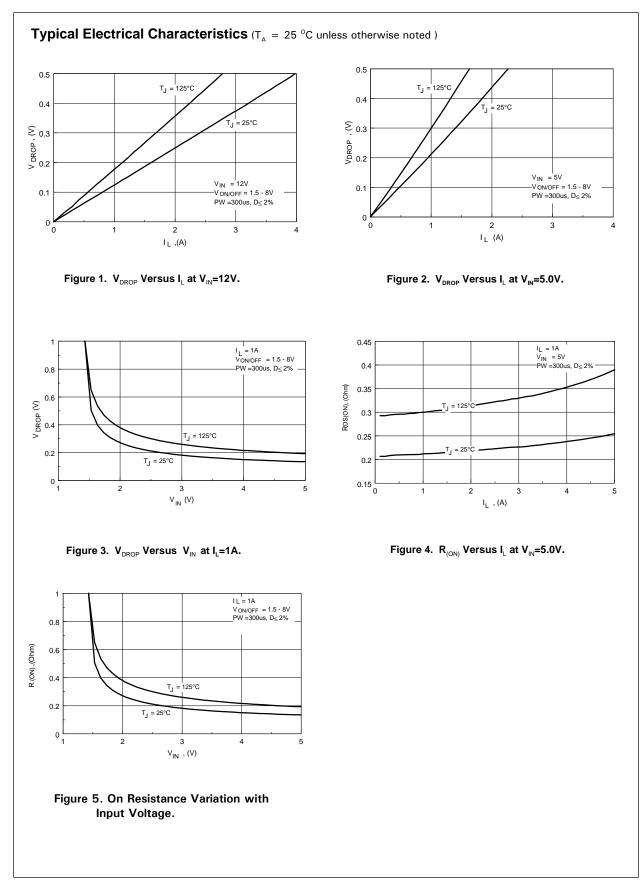
 $P_{D}(t) = \frac{T_{J} - T_{A}}{R_{0J} A(t)} = \frac{T_{J} - T_{A}}{R_{0,J} c^{+} R_{0,CI}(t)} = I_{D}^{2}(t) \times R_{DQ(OM) \otimes J}$ Typical R_{0A} for single device operation using the board layouts shown below on FR-4 PCB in a still air environment:

a. 180°C/W when mounted on a 2oz minimum copper pad.

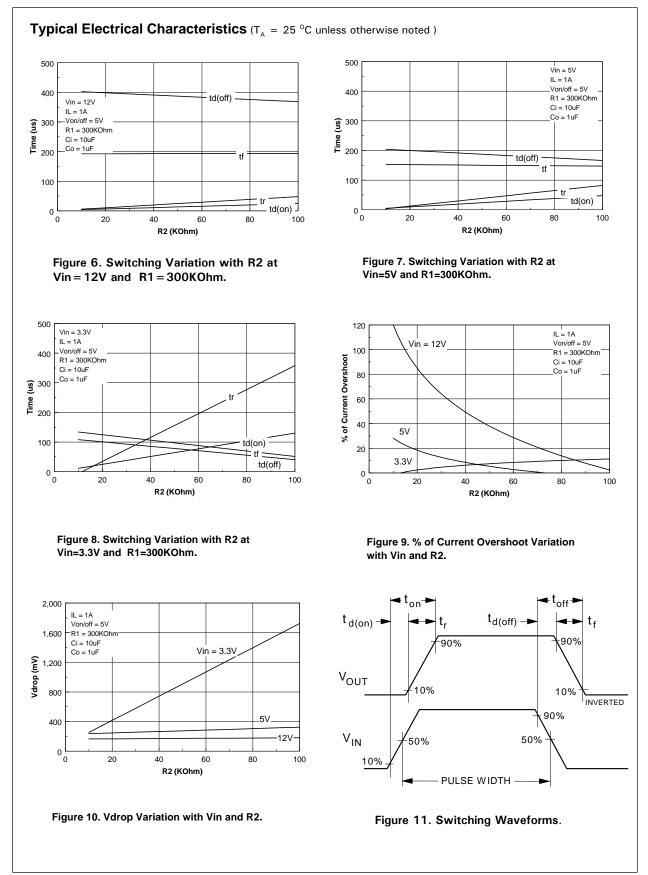


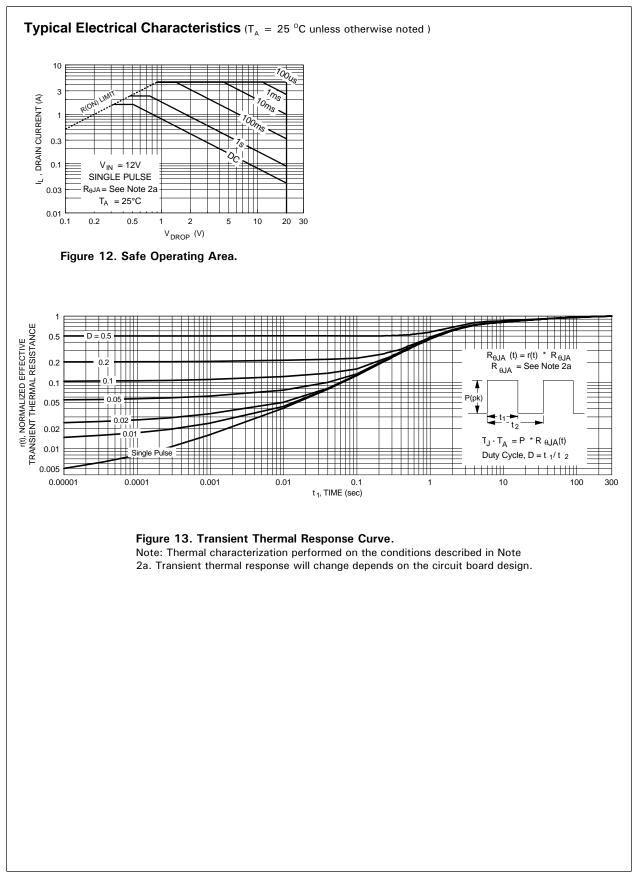
Scale 1 : 1 on letter size paper

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%

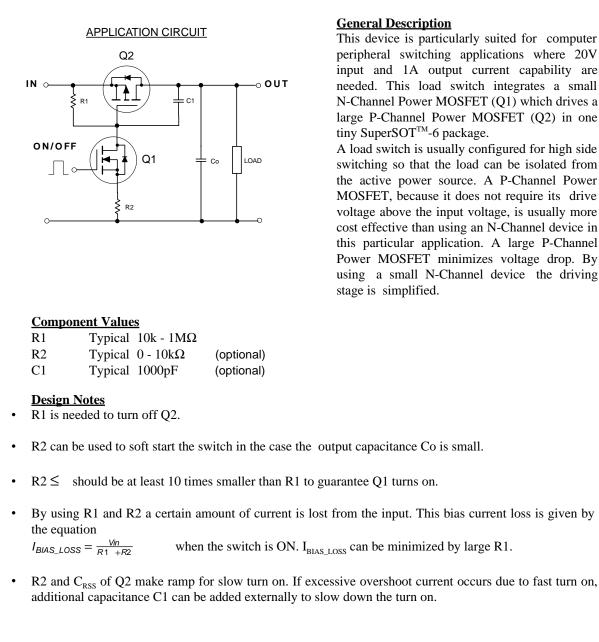


FDC6324L Rev.D





FDC6324L Load Switch Application

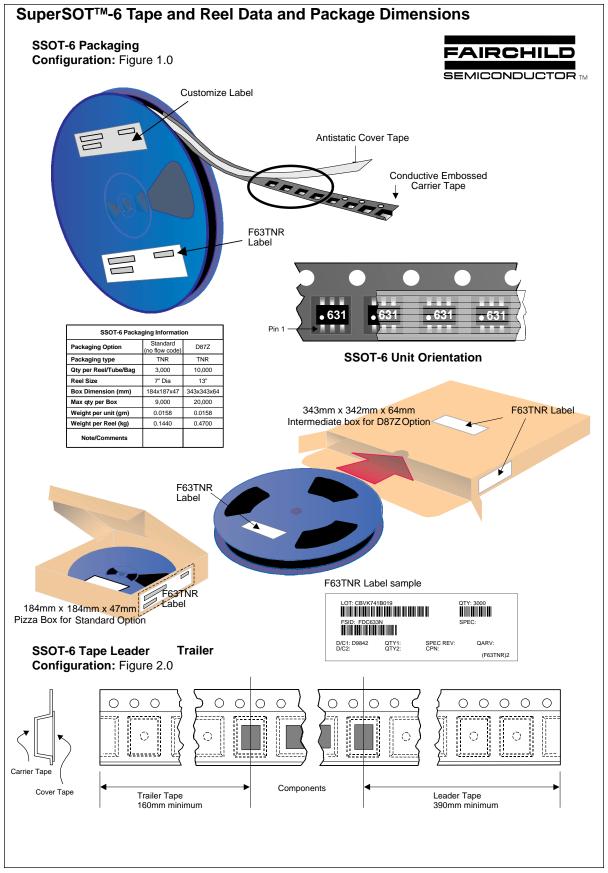


General Description

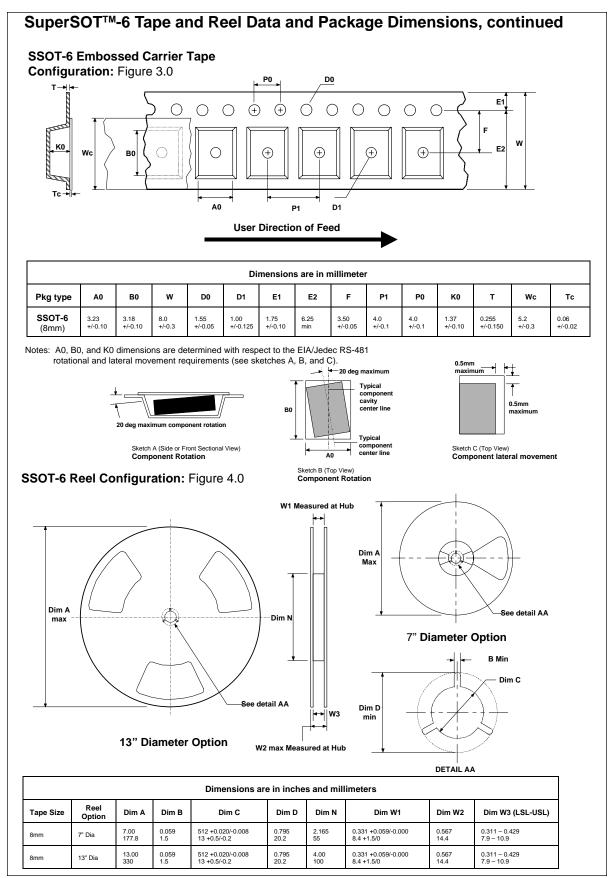
This device is particularly suited for computer peripheral switching applications where 20V input and 1A output current capability are needed. This load switch integrates a small N-Channel Power MOSFET (Q1) which drives a large P-Channel Power MOSFET (Q2) in one tiny SuperSOT[™]-6 package. A load switch is usually configured for high side

switching so that the load can be isolated from the active power source. A P-Channel Power MOSFET, because it does not require its drive voltage above the input voltage, is usually more cost effective than using an N-Channel device in this particular application. A large P-Channel Power MOSFET minimizes voltage drop. By using a small N-Channel device the driving stage is simplified.

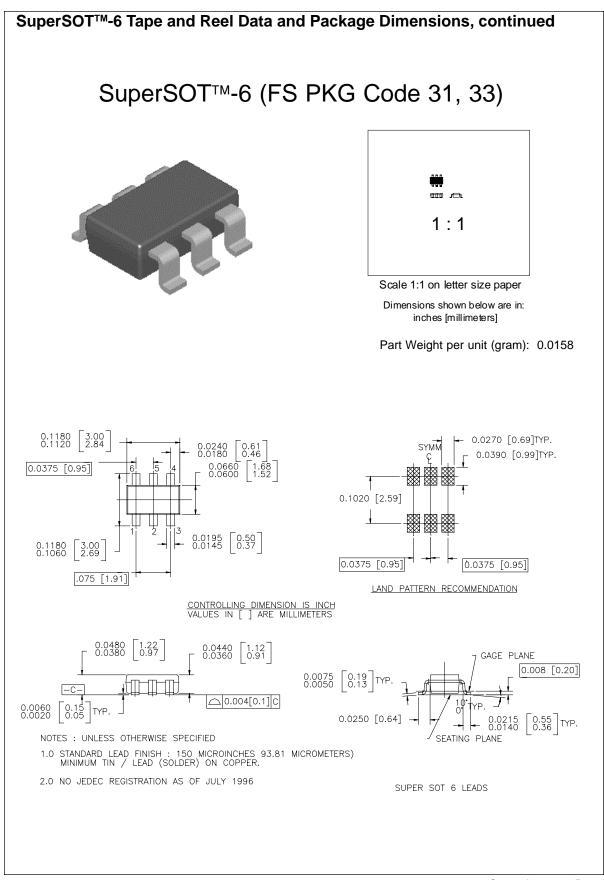
FDC6324L Rev. D



December 1998, Rev. B



December 1998, Rev. B



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